IGBT - Field Stop, Trench 650 V, 50 A

Product Preview FGHL50T65SQDT

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 4th generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(Sat)} = 1.47 \text{ V} (Typ.) @ I_C = 50 \text{ A}$
- 100% of the Parts tested for $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC

Table 1. MAXIMUM RATING

Symbol	Rating	Value	Unit
V _{CES}	Collector to Emitter Voltage	650	V
V _{GES}	Gate to Emitter Voltage Transient Gate to Emitter Voltage	±20 ±30	V
۱ _C	$ \begin{array}{ll} \mbox{Collector Current} & @\ T_C = 25^\circ C \\ & @\ T_C = 100^\circ C \end{array} $	100 50	A
I _{LM}	Pulsed Collector Current (Note 1)	200	А
I _{CM}	Pulsed Collector Current (Note 2)	200	А
١ _F	Diode Forward Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	75 50	A
I _{FM}	Pulsed Diode Maximum Forward Current	300	А
P _D	Maximum Power Dissipation @ T _C = 25°C @ T _C = 100°C	268 134	W
T _J , T _{STG}	Operating Junction / Storage Temperature Range	–55 to +175	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. VCC = 400 V, VGE = 15 V, IC = 200 A, RG = 3 Ω, Inductive Load, 100% Tested

2. Repetitive rating: pulse width limited by max. Junction temperature

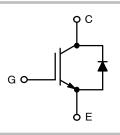
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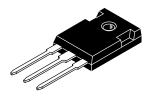


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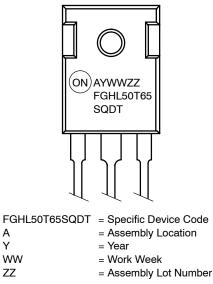
50 A, 650 V V_{CESat} = 1.47 V (Typ.)





TO-247-3LD CASE 340CX

MARKING DIAGRAM



ORDERING INFORMATION

A

Y

ΖZ

Device	Package	Shipping
FGHL50T65SQDT	TO-247-3L	30 Units / Rail

THERMAL CHARACTERISTICS

Symbol	Rating	Value	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, for IGBT	0.56	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max for Diode	0.65	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS		-	-	-	-
BV _{CES}	Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 1 mA	650	_	-	V
$\frac{\Delta \text{BV}_{\text{CES}}}{\Delta \text{T}_{j}}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	_	0.6	-	V/°C
I _{CES}	Collector-emitter cut-off current, gate-emitter short-circuited	V_{GE} = 0 V, V_{CE} = V_{CES}	_	-	250	μΑ
I _{GES}	Gate leakage current, collector-emitter short-circuited	$V_{GE} = V_{GES}, V_{CE} = 0 V$	Ι	_	±400	nA
ON CHARA	CTERISTICS					
V _{GE(th)}	Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 50 \text{ mA}$	2.6	4.5	6.4	V
V _{CE(sat)}	Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 50 A V _{GE} = 15 V, I _C = 50 A, T _c = 175°C	-	1.47 1.7	2.1 _	V
DYNAMIC C	HARACTERISTICS					
C _{ies}	Input capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	3081	-	pF
C _{oes}	Output capacitance	- - -	-	136	-	
C _{res}	Reverse transfer capacitance		-	10.8	-	
SWITCHING	CHARACTERISTICS, INDUCTIVE LOAD	•			-	
t _{d(on)}	Turn-on delay time	$T_{\rm C} = 25^{\circ}{\rm C}$	-	22.8	_	ns
t _r	Rise time	VČC = 400 V, IC = 12.5 A Rg = 4.7 Ω	-	5.20	_	
t _{d(off)}	Turn-off delay time	V _{GE} = 15 V Inductive Load	-	70	_	
t _f	Fall time		-	27.20	_	
Eon	Turn-on switching loss		-	223	_	μJ
Eo _{ff}	Turn-off switching loss		-	91.13	-	
E _{ts}	Total switching loss		-	314.13	-	
t _{d(on)}	Turn-on delay time	$T_{\rm C} = 25^{\circ}{\rm C}$	-	23.60	-	ns
t _r	Rise time	VCC = 400 V, IC = 25 A Rg = 4.7 Ω V _{GE} = 15 V Inductive Load	-	10.40	-	1
t _{d(off)}	Turn-off delay time		-	66.40	-	1
t _f	Fall time		-	10.20	-	1
Eon	Turn-on switching loss		-	515.60	-	μJ
E _{off}	Turn-off switching loss	1	-	133	-	1
E _{ts}	Total switching loss		-	648.60	-	

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

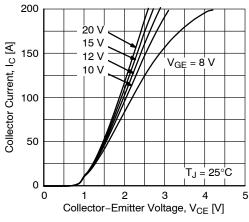
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
WITCHING	CHARACTERISTICS, INDUCTIVE LOA	ND				
t _{d(on)}	Turn-on delay time	$T_{\rm C} = 175^{\circ}{\rm C}$	-	23.60	-	ns
t _r	Rise time	VCC = 400 V, IC = 12.5 A Rg = 4.7 Ω	-	7.20	-	
t _{d(off)}	Turn-off delay time	V _{GE} = 15 V Inductive Load	-	87	_	
t _f	Fall time		-	72	-	
Eon	Turn-on switching loss		-	259.20	-	μJ
E _{off}	Turn-off switching loss		-	221	-	
E _{ts}	Total switching loss		-	480.20	-	
t _{d(on)}	Turn-on delay time	$T_{\rm C} = 175^{\circ}{\rm C}$	-	25.60	-	ns
t _r	Rise time	VCC = 400 V, IC = 25 A Rg = 4.7 Ω	-	14.80	-	
t _{d(off)}	Turn-off delay time	V _{GE} = 15 V Inductive Load	-	78	-]
t _f	Fall time		-	42	-	
Eon	Turn-on switching loss		-	578.90	-	μJ
E _{off}	Turn-off switching loss		-	406.80	-	
E _{ts}	Total switching loss		-	985.70	-	
Qg	Total Gate Charge	VCE = 400 V, IC = 50 A,	-	99.7	-	nC
Qge	Gate to Emitter Charge	VGE = 15 V	-	18.3	-	nC
Qgc	Gate to collector Charge		-	25.90	-	nC

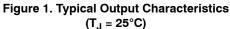
DIODE CHARACTERISTICS

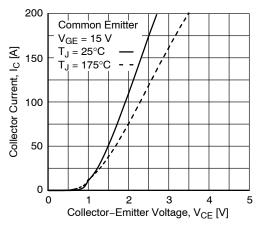
V _F	Forward voltage	$I_{F} = 50 \text{ A}, T_{c} = 25^{\circ}\text{C}$ $I_{F} = 50 \text{ A}, T_{c} = 175^{\circ}\text{C}$		2 1.6	2.6 _	V
Erec	Reverse Recovery Energy	I_F = 50 A, dI_F/dt = 200 A/µs, Tc=175°C	-	80.14	-	μJ
Trr	Diode Reverse Recovery Time	$\label{eq:IF} \begin{array}{l} IF=50~A,~dI_{\text{F}}/dt=200~A/\mu s\\ IF=50~A,~dI_{\text{F}}/dt=200~A/\mu s,\\ Tc=175^\circC \end{array}$	-	35.60 201	-	nS
Qrr	Diode Reverse Recovery Charge	$\label{eq:IF} \begin{array}{l} IF=50~A,~dI_{\text{F}}/dt=200~A/\mu s\\ IF=50~A,~dI_{\text{F}}/dt=200~A/\mu s,\\ Tc=175^\circC \end{array}$	-	66.22 1135.65	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

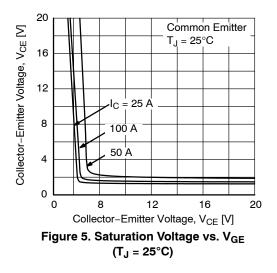
TYPICAL CHARACTERISTICS

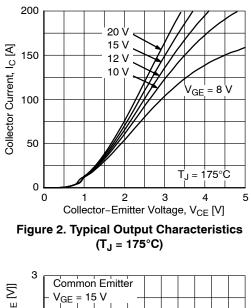












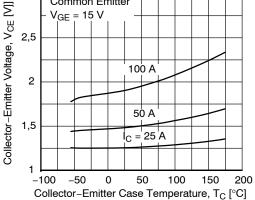
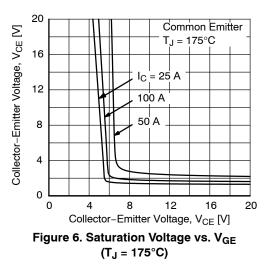


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level



TYPICAL CHARACTERISTICS (continued)

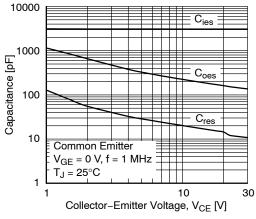
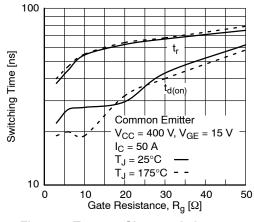
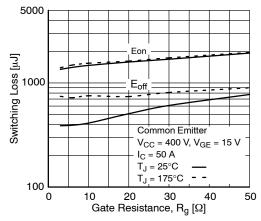


Figure 7. Capacitance Characteristics









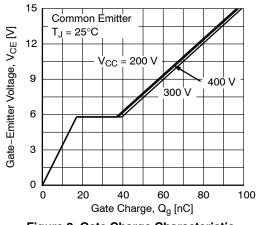


Figure 8. Gate Charge Characteristic

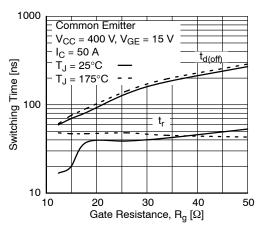


Figure 10. Turn–Off Characteristics vs. Gate Resistance

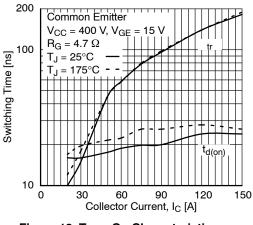
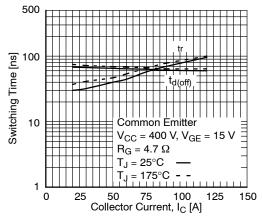
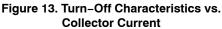


Figure 12. Turn-On Characteristics vs. Collector Current

TYPICAL CHARACTERISTICS (continued)





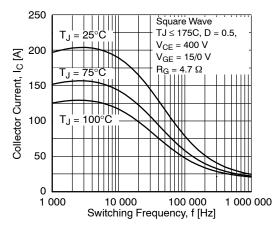


Figure 15. Load Current vs. Frequency

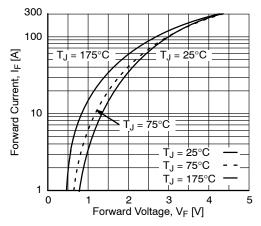


Figure 17. Forward Characteristics

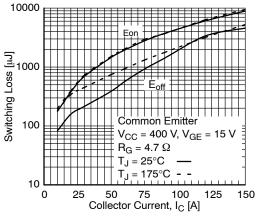


Figure 14. Switching Loss vs. Collector Current

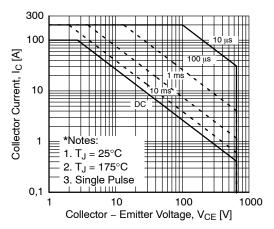


Figure 16. SOA Characteristics (FBSOA)

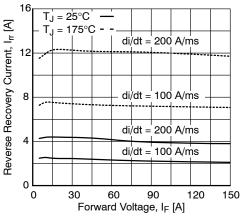
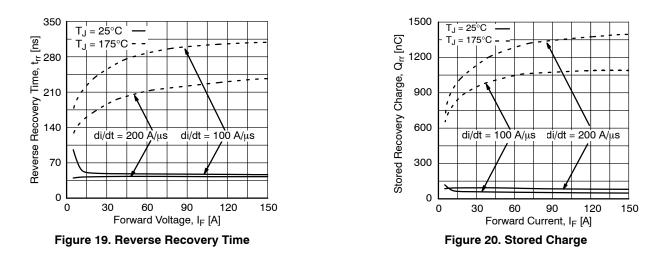
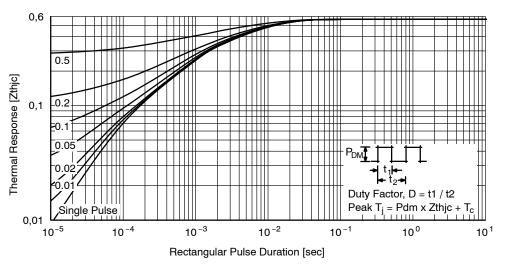


Figure 18. Reverse Recover Current

TYPICAL CHARACTERISTICS (continued)







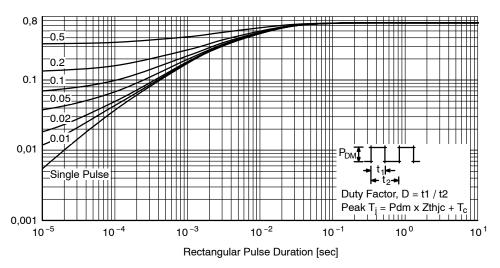
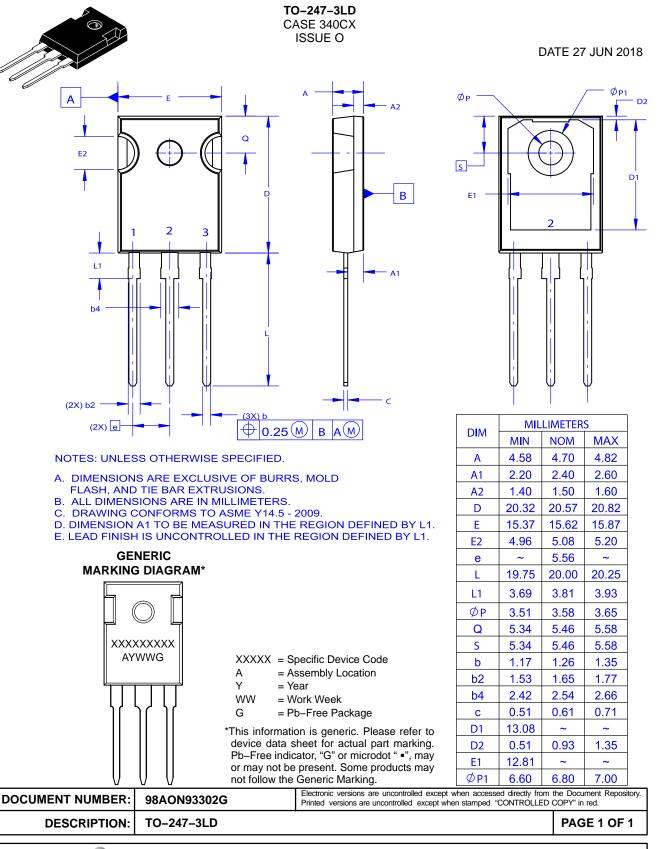


Figure 22. Transient Thermal Impedance of Diode



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